

CLAIMS

What is claimed is:

- 1 1. A system for measuring a height of an object comprising:
 - 2 a first electromagnetic signal source for transmitting a first signal toward a first position
 - 3 on the object at a first angle;
 - 4 a second electromagnetic signal source for transmitting a second signal toward said first
 - 5 position on the object at a second angle;
 - 6 a first retro-reflection unit for reflecting a first single reflected signal toward said first
 - 7 position on said object, wherein said first single reflected signal is a portion of said first signal
 - 8 that reflects off of the object;
 - 9 a first position sensitive detector to receive a first double reflected signal, wherein said
 - 10 first double reflected signal is a portion of said first single reflected signal that reflects off of said
 - 11 object and for generating a first output in response to said first double reflected signal;
 - 12 a second retro-reflection unit for reflecting a second single reflected signal toward said
 - 13 first position on said object, wherein said second single reflected signal is a portion of said
 - 14 second signal that reflects off of said object;
 - 15 a second position sensitive detector to receive a second double reflected signal wherein
 - 16 said second double reflected signal is a portion of said second single reflected signal that reflects
 - 17 off of said object and for generating a second output in response to said second double reflected
 - 18 signal; and
 - 19 a processor, that receives said first and second output and generates a material
 - 20 independent signal representing at least one of a height of said first position and a slope of said

21 first position, said material independent signal being independent of the type of material
22 comprising the object.

1 2. The system of claim 1 further comprising a spinning device for rotating the object
2 to change said first position.

1 3. The system of claim 1, wherein said object is one of a thin film disk and a
2 substrate.

1 4. The system of claim 1, wherein said object is a silicon wafer.

1 5. The system of claim 1, wherein said object is an optical component.

1 6. The system of claim 1, wherein said first and second electromagnetic signal
2 sources are lasers.

1 7. The system of claim 1, wherein said material independent signal is generated
2 without said laser and said position sensitive detectors contacting the object.

1 8. The system of claim 1, for measuring the height of said object at the first position
2 wherein a slope is ninety degrees, said slope representing the change in height between the first
3 position and an adjacent position on the object.